Trench-based Schottky Diode, 500 mA, 30 V

NSR05301MX4

These Schottky diodes are optimized for low forward voltage drop and low leakage current that offers the most optimal power dissipation in applications. They are housed in space saving micro-packaging ideal for space constrained applications.

Features

- Smallest Package Available (01005); 0.445mm x 0.24mm
- 500 mA of Continuous Forward Current
- Low Forward Voltage Drop 430 mV (Typical) @ I_F = 200 mA
- Low Reverse Current 25 μ A (Typical) @ V_R = 30 V
- Low Reverse Recovery Time 9 ns Typical
- Low Capacitance 19 pF Typical

Typical Applications

- Mobile and Wearable Devices
- LED Boost Converters
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Forward Current (DC)		١ _F	500	mA
Reverse Voltage		V _R	30	V
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)		I _{FRM}	1.0	A
ESD Rating:	Human Body Model Machine Model	ESD	>8.0 >400	kV V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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X4DFN2 CASE 718AA



D = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping†
NSR05301MX4T5G	X4DFN2 (Pb-Free)	10000 / Tape & Reel

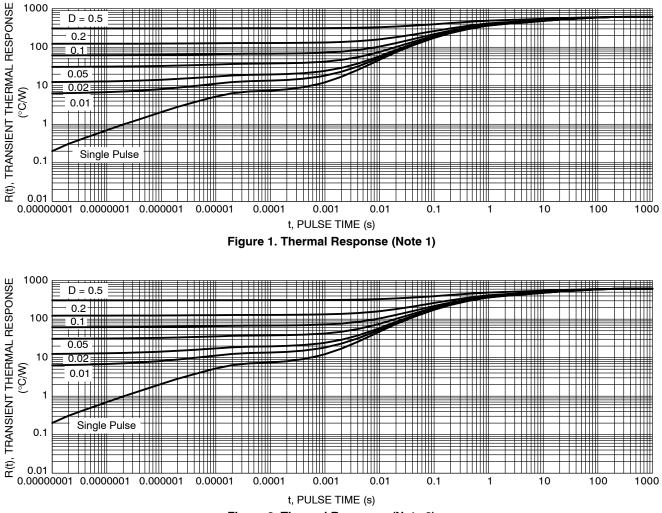
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	$R_{ heta JA} = P_D$	614.9 203	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D	239.4 522	°C/W mW
Junction Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
Lead Solder Temperature - Maximum (10 seconds)	TL	260	°C

1. Mounted onto a 4 in² FR-4 board 10 mm² 1 oz. Cu 0.06' thick single-sided. Operating to steady state.

2. Mounted onto a 4 in² FR-4 board 2 cm² 1 oz. Cu 0.06' thick single-sided. Operating to steady state.



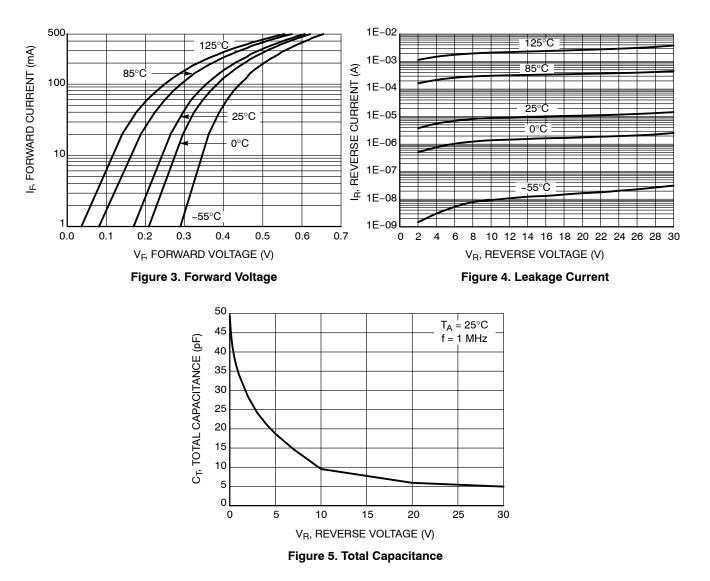


NSR05301MX4

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

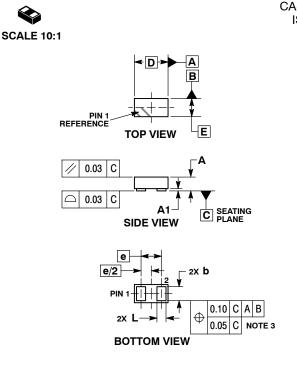
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage (V _R = 10 V) (V _R = 30 V)	۱ _R		15 25	50 100	μΑ
Forward Voltage (I _F = 100 mA) (I _F = 200 mA) (I _F = 500 mA)	V _F		355 430 640	480 540 800	mV
Total Capacitance (V _R = 5.0 V, f = 1 MHz)	C _T		19		pF
Reverse Recovery Time ($I_F = I_R = 10 \text{ mA}, I_{R(REC)} = 1.0 \text{ mA}$)	t _{rr}		9.0	11	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



TYPICAL CHARACTERISTICS

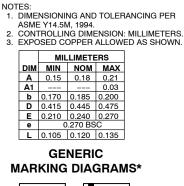




X4DFN2, 0.445x0.24, 0.27P CASE 718AA

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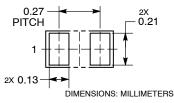




X = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT*



See Application Note AND8398/D for more mounting details

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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